

### Product Change Notification / MAAN-12TDMK498

# Date:

18-Dec-2023

# **Product Category:**

Memory

# PCN Type:

Manufacturing Change

# **Notification Subject:**

CCB 6760 Initial Notice: Qualification of ATP7 as an additional assembly site for selected SST38VF640x, SST39LF40x, SST39LF80xx, SST39VF16xx, SST39VF32xx, SST39VF40xx, SST39VF80xx, SST39WF160x, SST39WF800B and SST39WF400B device families available in 48L TFBGA (6x8x1.2mm) package.

## Affected CPNs:

MAAN-12TDMK498\_Affected\_CPN\_12182023.pdf MAAN-12TDMK498\_Affected\_CPN\_12182023.csv

## Notification Text:

PCN Status:Initial Notification

PCN Type:Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of ATP7 as an additional assembly site for selected SST38VF640x, SST39LF40x, SST39LF80xx, SST39VF16xx, SST39VF32xx, SST39VF40xx, SST39VF80xx, SST39WF160x, SST39WF800B and SST39WF400B device families available in 48L TFBGA (6x8x1.2mm) package.

#### Pre and Post Change Summary:

	Pre Change	Post Change					
Assembly Site	Lingsen Precision Industries, LTD. (LPI)	Lingsen Precision Industries, LTD. (LPI)	Amkor Technology Philippines (P3/P4), INC. (ATP7)				
Core Material	HL832NXA	HL832NXA	HL832NXA				
SM Material	AUS308	AUS308	AUS308				
Wire Material	Au	Au	Au				
Die attach Material	2100A	2100A	2300				
Molding Compound Material	G770HT	G770HT	G770FE				
Solder Ball Material	SAC405	SAC405	SAC405				

#### Impacts to Data Sheet:None

#### Change ImpactNone

**Reason for Change:**To improve on-time delivery performance by qualifying ATP7 as an additional assembly site.

#### Change Implementation Status: In Progress

#### Estimated Qualification Completion Date: May 2024

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts.

#### Time Table Summary:

	December 2023				>	May 2024					
Workweek	4 8	4 9	5 0	5 1	5 2		18	19	20	21	22
Initial PCN Issue Date				х							
Qual Report Availability							х				
Final PCN Issue							Х				

# Date

Method to Identify Change: Traceability code

**Qualification Plan:**Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Plan.

Revision History: December 18, 2023: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

## Attachments:

## PCN\_MAAN-12TDMK498\_Qual Plan.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

#### **Terms and Conditions:**

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our PCN home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the PCN FAQ section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.